

PRESS RELEASE

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Promising material for industry

World's first production of aluminum scandium nitride via MOCVD

Scientists at the Fraunhofer Institute for Applied Solid State Physics IAF have achieved what was previously considered impossible: they are the first in the world who have managed to manufacture aluminum scandium nitride (AlScN) via metal-organic chemical vapor deposition (MOCVD). Devices based on AlScN are considered to be the next generation of power electronics. With this breakthrough, Fraunhofer IAF takes a decisive step towards its goal of developing power electronics based on AlScN transistors for industrial applications.

Transistors based on AlScN are promising for various industrial applications, such as data transfer, satellite communication, radar systems or autonomous driving, especially since current devices based on silicon (Si) are reaching their physical limit in these applications. One reason for this is the size of Si devices, which cannot be reduced any more according to the current state of research. If the ever-increasing amounts of data had to be processed with the current Si technology, the server rooms would occupy such a large area that it would be economically and ecologically unsustainable. So-called HEMTs (high electron mobility transistors) surpass the possibilities of Si devices by far. The key to the success of HEMT structures lies in the materials they are based on. AlScN has exceptional properties, allowing higher carrier concentrations than other materials. In the future, significantly more powerful and efficient HEMTs will be realized based on AlScN.

Previous manufacturing processes have failed due to quality and productivity

The production of AlScN involves fundamental challenges. The state-of-the-art production process grows AlScN layers via sputtering. Unfortunately, the quality of these layers is insufficient for electronic applications such as LEDs and high-power transistors. An alternative method is to produce AlScN via molecular beam epitaxy (MBE). With this process, high amounts of scandium can be incorporated in the compound. The quality is also sufficient for the production of microelectronic devices. However, the procedure is very complex and the productivity too low for industrial scale productions.

Editor

Dr. Anne-Julie | Fraunhofer Institute for Applied Solid State Physics IAF |
+49 761 5159-282 | Tullastrasse 72 | 79108 Freiburg, Germany | www.iaf.fraunhofer.de | anne-julie.maurer@iaf.fraunhofer.de

Metal-organic chemical vapor deposition promises industrial-grade production

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The production of AlScN via MOCVD promises not only the necessary quality, but also sufficient productivity for industrial applications. "We knew that previous attempts by other scientists to produce gallium scandium nitride via MOCVD had failed. We also know that many scientists all over the world are working to develop AlScN transistors, but no one before us has succeeded in doing it by using MOCVD, even though it is a very promising approach for industry", explains Dr Stefano Leone, group leader at Fraunhofer IAF. During the MOCVD procedure gases are guided across a heated wafer. Through the heat exposure distinct molecules are released from the gas and integrated into the crystalline structure of the wafer. The crystal structure can be precisely adjusted by regulating the gas flow, temperature and pressure. Furthermore, the quick change of gas allows to grow different material layers on top of each other.

Fraunhofer IAF achieves novelty

The challenge for the researchers at Fraunhofer IAF: there is no gas source for scandium. The molecules (precursors) for scandium are very large and difficult to bring into the gas phase. "We studied the best possible precursor for scandium and planned adjustments of our MOCVD reactor for the necessary procedure. We did a lot of research and had numerous discussions until we developed a setup that we are now even patenting. We have now succeeded in growing AlScN layers via MOCVD with a very high crystal quality and the right amount of scandium in order to develop the next generation of power transistors", says Leone, pleased with the achievement. The MOCVD system at Fraunhofer IAF has been modified by the research group to enable a high-quality and reproducible AlScN production process.

First AlScN layers for transistors from the MOCVD

After the successful deposition of AlScN in the MOCVD system, the first AlScN layers for transistors were produced. The layers already reach promising results with a sheet resistance of ~200 ohm/sq., a mobility of ~600 cm²/Vs and a charge carrier density of ~4,0 x 10¹³ cm⁻². The current goal of the scientists is to reduce the sheet resistance and to further increase the mobility and material quality. This will improve the performance of future transistors and Fraunhofer IAF will take a significant step towards its goal of providing AlScN HEMTs for industrial power electronic applications.

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About Fraunhofer IAF

The Fraunhofer Institute for Applied Solid State Physics IAF ranks among the leading research institutions in the field of compound semiconductors. Based on these semiconductors, IAF develops electronic and optoelectronic components as well as integrated circuits and systems. In a clean room of 1000 m² and additional laboratory space covering 3000 m², epitaxy and processing equipment along with measurement technologies are available to realize high frequency circuits for communication technology, voltage converter modules for electrical engineering, infrared and UV detectors for safety and security applications, as well as infrared laser systems for medical technology.

Images:



Scientists at Fraunhofer IAF are the world's first to produce aluminum scandium nitride (AlScN) via metal-organic chemical vapor deposition (MOCVD). The research group of Stefano Leone (bottom right) is proud of their success.

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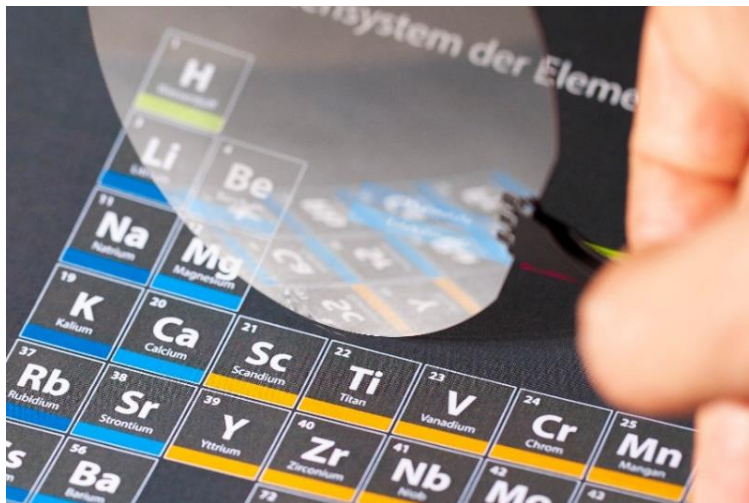


The MOCVD system of Fraunhofer IAF has been modified by the research group to enable the growth of AlScN with sufficient quality and productivity for industry.

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The AlScN layers have a very high crystal quality and the right amount of scandium, with which the scientists want to develop the next generation of electronic power transistors.

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